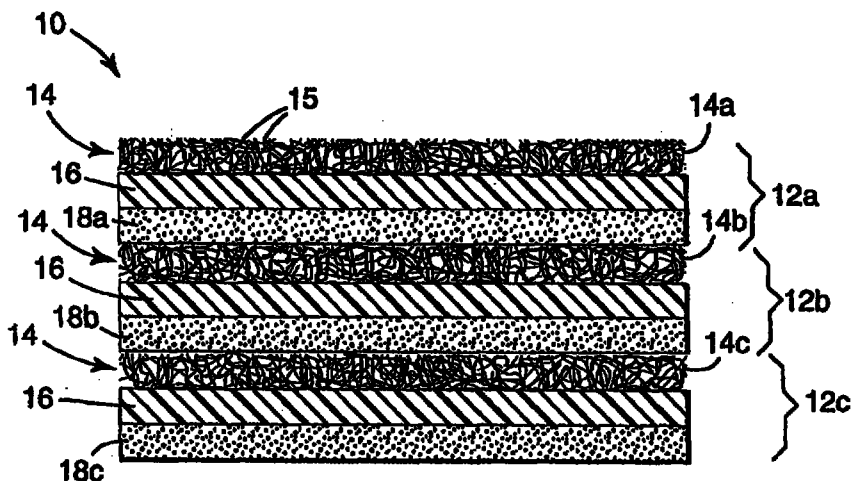




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(21) International Application Number: PCT/US98/05607 (22) International Filing Date: 23 March 1998 (23.03.98) (30) Priority Data: 08/965,250 6 November 1997 (06.11.97) US (71) Applicant: MINNESOTA MINING AND MANUFACTURING COMPANY [US/US]; 3M Center, P.O. Box 33427, Saint Paul, MN 55133-3427 (US). (72) Inventor: SETH, Jayshree; P.O. Box 33427, Saint Paul, MN 55133-3427 (US). (74) Agents: BOND, William, J. et al.; Minnesota Mining and Manufacturing Company, Office of Intellectual Property Counsel, P.O. Box 33427, Saint Paul, MN 55133-3427 (US).		(81) Designated States: AL, AM, AT, AU, AZ, BA, BB, BG, BR, BY, CA, CH, CN, CU, CZ, DE, DK, EE, ES, FI, GB, GE, GH, GM, GW, HU, ID, IL, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MD, MG, MK, MN, MW, MX, NO, NZ, PL, PT, RO, RU, SD, SE, SG, SI, SK, SL, TJ, TM, TR, TT, UA, UG, UZ, VN, YU, ZW, ARIPO patent (GH, GM, KE, LS, MW, SD, SZ, UG, ZW), Eurasian patent (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European patent (AT, BE, CH, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE), OAPI patent (BF, BJ, CF, CG, CI, CM, GA, GN, ML, MR, NE, SN, TD, TG). Published <i>With international search report.</i>

(54) Title: NONWOVEN PRESSURE SENSITIVE ADHESIVE TAPE**(57) Abstract**

A storage/dispensing assembly, e.g., a roll or stack, of non woven pressure sensitive adhesive tape comprising one or more multilayer sheets of pressure sensitive adhesive tape arranged such that the adhesive layer in the assembly of an overlying non woven pressure sensitive adhesive tape is in direct contact with the underlying nonwoven backing layer of non woven pressure sensitive adhesive tape. The non woven backing layer is formed at least in part of fibers having a denier of greater than 15 so as to decrease the level of fibers disengagement when an overlying nonwoven pressure sensitive adhesive tape is removed from the assembly.